

**INFORMATION
DISCLOSURE
STATEMENT**

Application No.: 10/764,011

Sheet 1 of 1

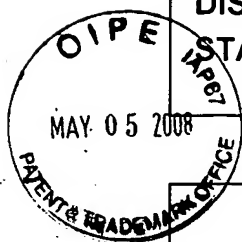
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Applicant: Pedlow, Jr. et al.



U.S. PATENT DOCUMENTS

Exam. Init.	Document Number	Issue/Pub. Date	Name	Class	Filing Date
	5,629,866	05/13/1997	Carrubba et al.		03/20/1995
	6,201,927	03/13/2001	Comer		02/13/1998
	6,327,421	12/04/2001	Tiwari et al.		03/10/1998
	2002/0067436	06/06/2002	Shirahama et al.		05/11/2001
	2002/0144116	10/03/2002	Giobbi		05/23/2002
	2002/0157115	10/24/2002	Lu		04/24/2001
	6,490,728	12/03/2002	Kitazato et al.		07/13/1999
	2003/0021412	01/30/2003	Candelore et al.		01/02/2002
	2004/0264924	12/30/2004	Campisano et al.		06/26/2003
	6,853,728	02/08/2005	Kahn et al.		07/21/2000
	6,925,180	08/02/2005	Iwamura		09/27/2001
	7,089,579	08/08/2006	Mao et al.		12/06/1999
	7,096,487	08/22/2006	Gordon et al.		12/09/1999
	7,110,659	09/19/2006	Fujie et al.		06/21/2001
	7,194,758	03/20/2007	Waki et al.		04/28/2000
	7,292,692	11/06/2007	Bonan et al.		01/29/2004

FOREIGN PATENT DOCUMENTS

Exam. Init.	Document Number	Date	Country	Class	Translation

OTHER DOCUMENTS / CITATIONS

Exam. Init.	Document

Examiner:

Date: